

Sonde de test de force de ressort 200g pour test PCB

Information produit

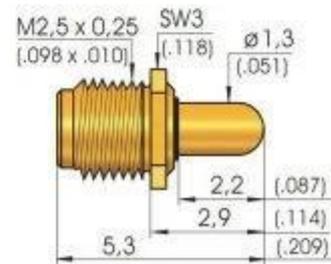
SFENG



SFENG



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Nom du produit	Sonde de test de force de ressort 200g pour test PCB
Taille	50mil 75mil 100mil ou broche pogo personnalisée
Ration actuelle	0-50A
Force de ressort	personnalisé
Résistance de contact	50m Ω

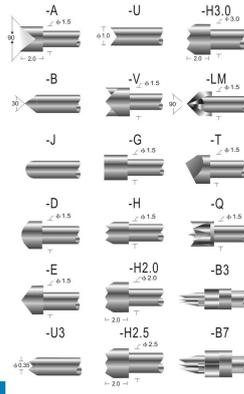
SF-P100



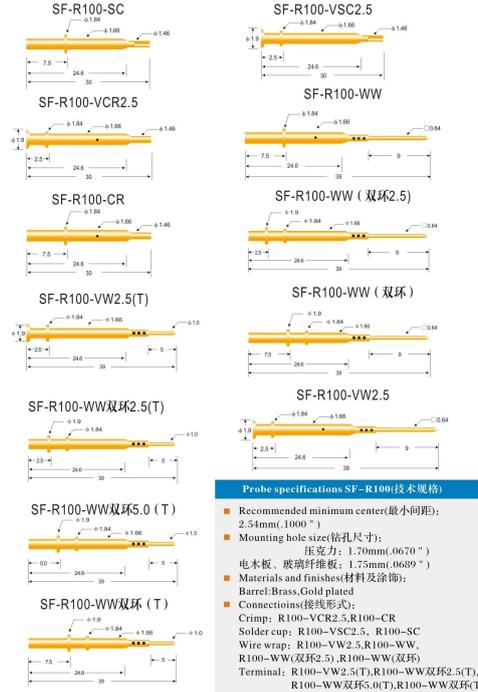
SF-P100-E

Probe specifications SF-P100(技术规格)

- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Full travel(行程): 6.40(.2520")
- Spring force(弹簧压力): 200g
- Materials and finishes(材料及涂饰): Plunger: Be Cu, Rh plated; SK4, Rh plated Barrel: Brass, Gold plated Spring: Stainless steel
- Current rating(额定电流): 3A(安培)
- Contact resistance(接触电阻): 50mΩ(毫欧姆)



SF-R100



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- Recommended minimum center(最小间距): 2.54mm(.1000")
- Mounting hole size(钻孔尺寸): 压克力: 1.70mm(.0670") 电木板、玻璃纤维板: 1.75mm(.0689")
- Materials and finishes(材料及涂饰): Barrel: Brass, Gold plated
- Connections(接线形式): Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环)
- Terminal: R100-VW2.5(T), R100-WW双环2.5(T), R100-WW双环5.0(T), R100-WW双环(T)

Production Couler



1. Raw material warehouse



2. Lathe workshop



3. Assemble workshop



4. Quality inspection



5. Finished products



6. Packing

Tester Équipement



1. Agilent current testing



2. Quadratic element



3. Load Curve Meter



4. Bond Test



5. Life Fatigue Test



6. Microscope

Emballage et expédition

Standard products will be delivered out within 3 days. Customized products will be sent out within 15 days.

